

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com









RJ45 transmitter sockets (magnetics) for gigabit applications (1000 base-T) with integrated compensation actively counteracts inductive and capacitive couplings and saves space on the PCB.

The product range encompasses the following designs:

- 90°, lying (horizontal) and 180°, standing (vertical)
- latch up / latch down
- THT, THR or SMD soldering processes
- Wide range of different design types, also with integrated LEDs and shield contact tabs
- Transmission rates of up to 1 Gbps
- Packed either in a tray (TY) or on a roll (tape-on-reel, RL)
- $\bullet$  Compatible with modular RJ45 connector according to ANSI / TIA-1096-A and IEC 60603
- Dielectric strength ≥1500 V AC RMS (2250 V AC peak value) according to IEEE 802.3
- Dielectric strength ≥1500 V AC (peak value) or ≥1500 V DC according to IEC 60603
- Compliance with IEEE 802.3 requirements (1000Base-T, 1 Gbps, IEEE 802.3ab or 100Base-Tx, 100 Mbps, IEEE 802.3u)

Properties and advantages:

- Extended temperature range of -40 °C to +85 °C for maximum performance
- $\bullet$  Reinforced gold layer (30 $\mu^{\prime\prime})$  for improved corrosion protection

At least 0.3mm stand-off ensures a perfect soldering result

#### **General ordering data**

Version	PCB plug-in connector, RJ45 jacks transformer, THT/THR solder connection, 90°, Latch option: bottom, Number of poles: 8, Tape		
Order No.	<u>2638860000</u>		
Туре	RJ45G1 R1D 3.3E4GY/GY RL		
GTIN (EAN)	4050118657098		
Qty.	200 pc(s).		
Packaging	Tape		

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# **Technical data**

Net weight	0.025 g		
System specifications			
Latch option	bottom	Mounting onto the PCB	THT/THR solder connection
Number of poles	8	Outgoing elbow	90°
Pitch in inches (P)	0.05 inch	Pitch in mm (P)	1.27 mm
Product family	OMNIMATE Data - RJ45 transformer jack	Protection degree	IP20
Soldering process	Reflow soldering, Manual soldering, Wave soldering		
Electrical properties			
Dielectric strength, contact / contact	1000 V DC	Dielectric strength, contact / shield	1500 V DC
	1000 V BO	Diciocatic strongar, contact / smela	1000 V DO
Packing			
D. I	<del>-</del>	VDE	
Packaging	Tape	VPE length	0 m
VPE width	0 m	VPE height	0 m
Classifications			
	E000000		
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01
Approvals			
ROHS	Conform		
Downloads			
	CTED		
Engineering Data Brochure/Catalogue	STEP Catalogues in PDF-format		
	Latalogues in PLIE-tormat		



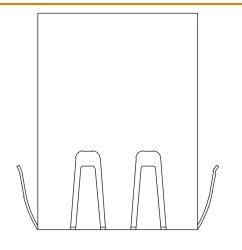
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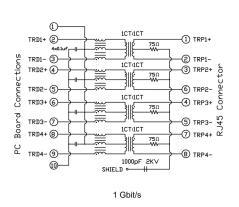
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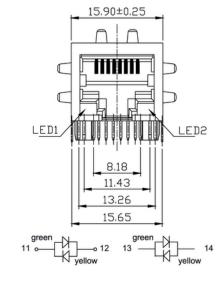
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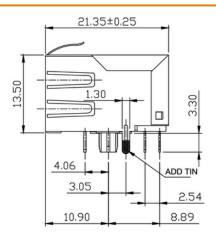
## **Drawings**

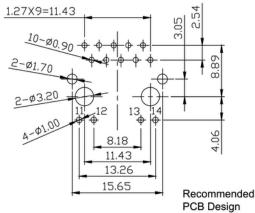
## Wiring

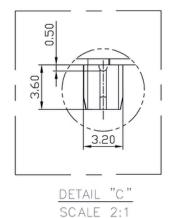














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## **Drawings**

#### Characteristics

Inductance 350 µH min. @ 100 kHz,

100 mV, 8 mA DC Bias

 Leakage Inductance
 0.3 μH max. @ 100 kHz,100 mV

 Insertion Loss
 1.1 dB max. @ (1 - 100) MHz

 Return Loss
 18 dB min. @ (1 - 30) MHz

 16 dB min. @ (30 - 60) MHz

12 dB min. @ (60 - 80) MHz

Cross Talk 30 dB min. @ (1 - 100) MHz Common Mode Rejection 30 dB min. @ (1 - 100) MHz

Type codes



## Recommended wave solderding profiles

#### Weidmüller Interface GmbH & Co. KG

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### Single Wave:



#### **Double Wave:**



### Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.



## Recommended reflow soldering profile

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### Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.